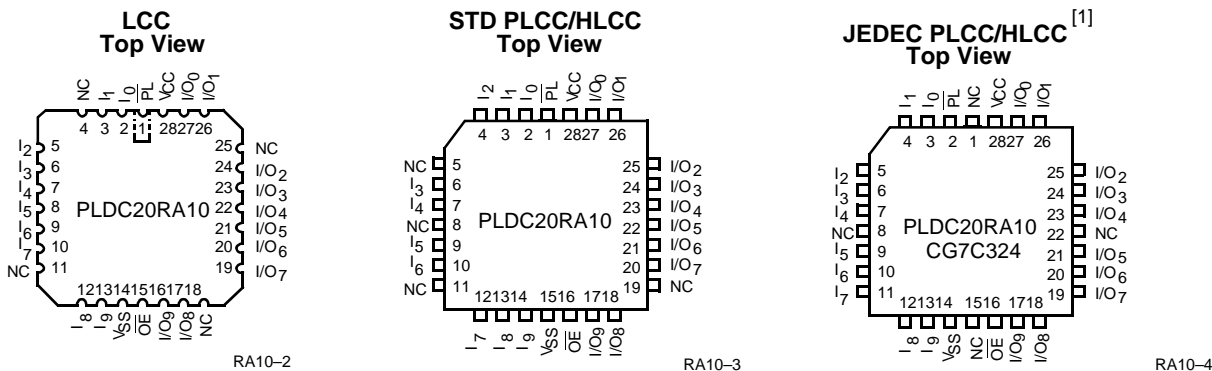


## Selection Guide

Generic Part Number	$t_{PD}$ ns		$t_{SU}$ ns		$t_{CO}$ ns		$t_{CC}$ ns	
	Com'l	Mil	Com'l	Mil	Com'l	Mil	Com'l	Mil
20RA10-15	15		7		15		80	
20RA10-20	20	20	10	10	20	20	80	85
20RA10-25		25		15		25		85
20RA10-35		35		20		35		85

## Pin Configurations



## Macrocell Architecture

Figure 1 illustrates the architecture of the 20RA10 macrocell. The cell dedicates three product terms for fully asynchronous control of the register set, reset, and clock functions, as well as, one term for control of the output enable function.

The output enable product term output is ANDed with the input from pin 13 to allow either product term or hardwired external control of the output or a combination of control from both sources. If product-term-only control is selected, it is automatically chosen for all outputs since, for this case, the external output enable pin must be tied LOW. The active polarity of each output may be programmed independently for each output cell and is subsequently fixed. Figure 2 illustrates the output enable options available.

When an I/O cell is configured as an output, combinatorial-only capability may be selected by forcing the set and reset product term outputs to be HIGH under all input conditions. This is achieved by programming all input term programming cells for these two product terms. Figure 3 illustrates the available output configuration options.

An additional four uncommitted product terms are provided in each output macrocell as resources for creation of user-defined logic functions.

## Programmable I/O

Because any of the ten I/O pins may be selected as an input, the device input configuration programmed by the user may vary from a total of nine programmable plus ten dedicated inputs (a total of nineteen inputs) and one output down to a ten-input, ten-output configuration with all ten programmable I/O cells configured as outputs. Each input pin available in a given configuration is available as an input to the four control

product terms and four uncommitted product terms of each programmable I/O macrocell that has been configured as an output.

An I/O cell is programmed as an input by tying the output enable pin (pin 13) HIGH or by programming the output enable product term to provide a LOW, thereby disabling the output buffer, for all possible input combinations.

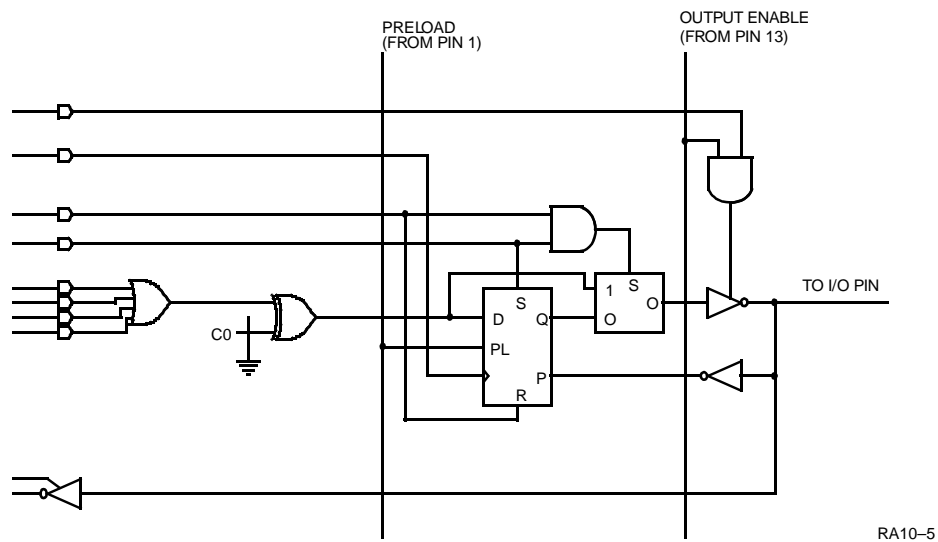
When utilizing the I/O macrocell as an output, the input path functions as a feedback path allowing the output signal to be fed back as an input to the product term array. When the output cell is configured as a registered output, this feedback path may be used to feed back the current output state to the device inputs to provide current state control of the next output state as required for state machine implementation.

## Preload and Power-Up Reset

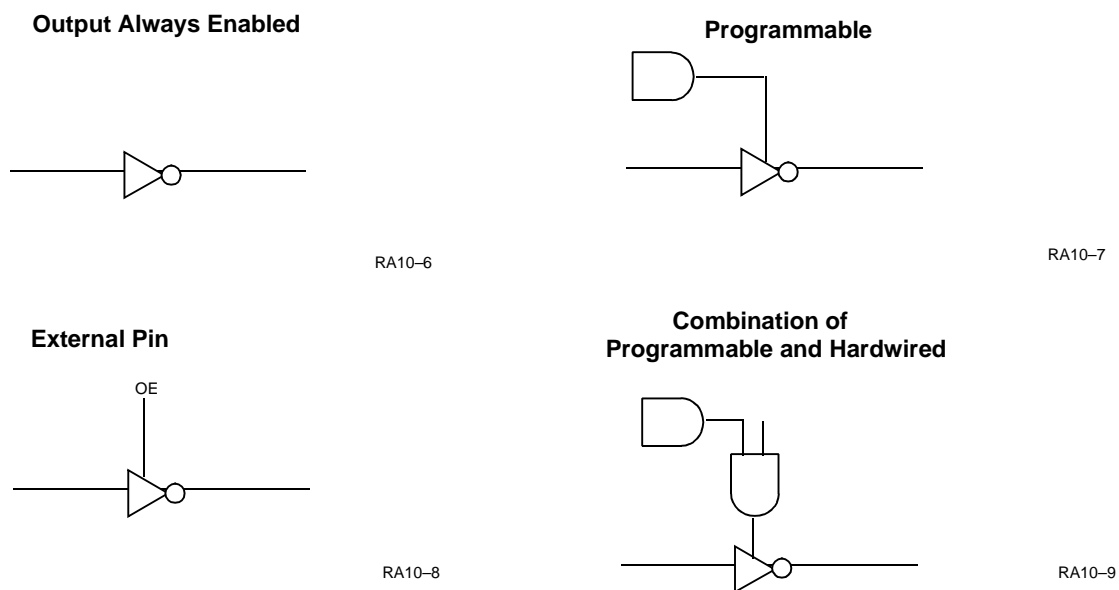
Functional testability of programmed devices is enhanced by inclusion of register preload capability, which allows the state of each register to be set by loading each register from an external source prior to exercising the device. Testing of complex state machine designs is simplified by the ability to load an arbitrary state without cycling through long test vector sequences to reach the desired state. Recovery from illegal states can be verified by loading illegal states and observing recovery. Preload of a particular register is accomplished by impressing the desired state on the register output pin and lowering the signal level on the preload control pin (pin1) to a logic LOW level. If the specified preload set-up, hold and pulse width minimums have been observed, the desired state is loaded into the register. To insure predictable system initialization, all registers are preset to a logic LOW state upon power-up, thereby setting the active LOW outputs to a logic HIGH.

### Note:

1. The CG7C324 is the PLDC20RA10 packaged in the JEDEC-compatible 28-pin PLCC pinout. Pin function and pin order is identical for both PLCC pinouts. The principal difference is in the location of the "no connect" (NC) pins



**Figure 1. PLDC20RA10 Macrocell**





### Registered/Active LOW

RA10-10

### Combinatorial/Active LOW

RA10-11

### Registered/Active HIGH

RA10-12

### Combinatorial/Active HIGH

RA10-13

## Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... -65°C to +150°C

Ambient Temperature with Power Applied..... -55°C to +125°C

Supply Voltage to Ground Potential (Pin 24 to Pin 12) ..... -0.5V to +7.0V

DC Voltage Applied to Outputs in High Z State ..... -0.5V to +7.0V

DC Input Voltage..... -3.0 V to + 7.0 V

Output Current into Outputs (LOW) ..... 16 mA

Static Discharge Voltage ..... >2001V (per MIL-STD-883, Method 3015)

Latch-Up Current..... >200 mA

DC Program Voltage ..... 13.0V

## Operating Range

Range	Ambient Temperature	V <sub>CC</sub>
Commercial	0°C to +75°C	5V ± 10%
Military <sup>[2]</sup>	-55°C to +125°C	5V ± 10%

## Electrical Characteristics Over the Operating Range<sup>[3]</sup>

Parameter	Description	Test Conditions			Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -3.2 mA	Com'l	2.4		V
			I <sub>OH</sub> = -2 mA	Mil			
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 8 mA			0.5	V
V <sub>IH</sub>	Input HIGH Level	Guaranteed Input Logical HIGH Voltage for All Inputs <sup>[4]</sup>			2.0		V
V <sub>IL</sub>	Input LOW Level	Guaranteed Input Logical LOW Voltage for All Inputs <sup>[4]</sup>				0.8	V
I <sub>IX</sub>	Input Leakage Current	V <sub>SS</sub> ≤ V <sub>IN</sub> ≤ V <sub>CC</sub> , V <sub>CC</sub> = Max			-10	+10	μA
I <sub>OZ</sub>	Output Leakage Current	V <sub>CC</sub> = Max., V <sub>SS</sub> ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub>			-40	+40	μA
I <sub>SC</sub>	Output Short Circuit Current <sup>[5]</sup>	V <sub>CC</sub> = Max., V <sub>OUT</sub> = 0.5V <sup>[6]</sup>			-30	-90	mA
I <sub>CC1</sub>	Standby Power Supply Current	V <sub>CC</sub> = Max., V <sub>IN</sub> = GND Outputs Open	Com'l			75	mA
			Mil			80	mA
I <sub>CC2</sub>	Power Supply Current at Frequency <sup>[5]</sup>	V <sub>CC</sub> = Max., Outputs Disabled (In High Z State) Device Operating at f <sub>MAX</sub>	Com'l			80	mA
			Mil			85	mA

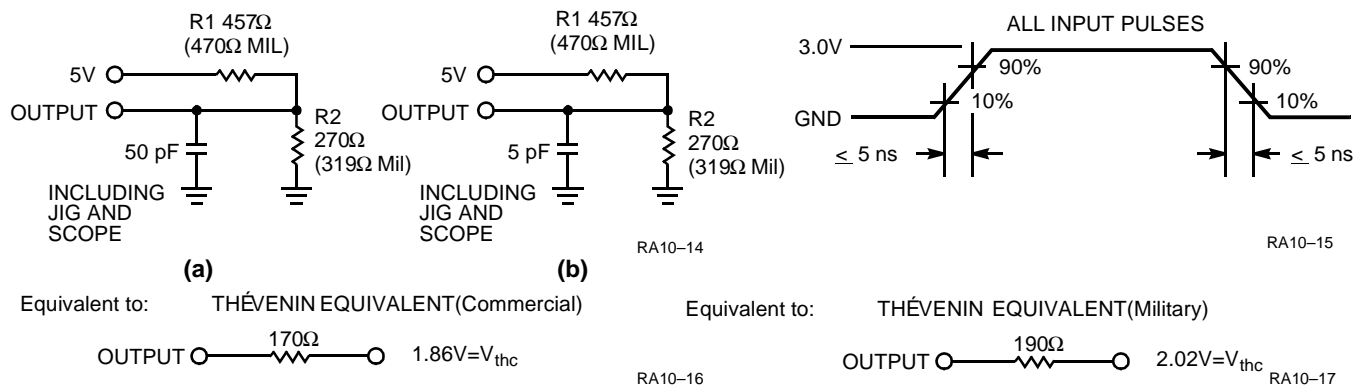
## Capacitance<sup>[5]</sup>

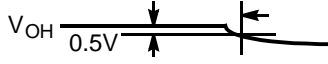
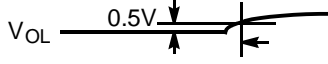
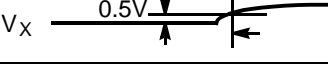
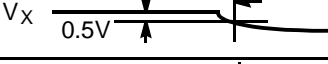
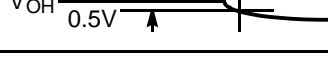
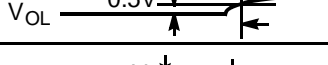
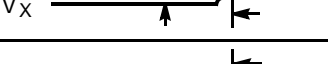
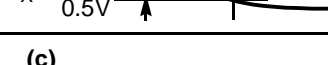
Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 2.0 V @ f = 1 MHz	10	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 2.0 V @ f = 1 MHz	10	pF

### Notes:

- T<sub>A</sub> is the "instant on" case temperature.
- See the last page of this specification for Group A subgroup testing information.
- These are absolute values with respect to device ground and all overshoots due to system or tester noise are included.
- Tested initially and after any design or process changes that may affect these parameters.
- Not more than one output should be tested at a time. Duration of the short circuit should not be more than one second. V<sub>OUT</sub> = 0.5 V has been chosen to avoid test problems caused by tester ground degradation.

## AC Test Loads and Waveforms (Commercial)



Parameter	$V_{th}$	Output Waveform Measurement Level
$t_{PXZ(-)}$	1.5V	 RA10-18
$t_{PXZ(+)}$	2.6V	 RA10-19
$t_{PZX(+)}$	$V_{thc}$	 RA10-20
$t_{PZX(-)}$	$V_{thc}$	 RA10-21
$t_{ER(-)}$	1.5V	 RA10-22
$t_{ER(+)}$	2.6V	 RA10-23
$t_{EA(+)}$	$V_{thc}$	 RA10-24
$t_{EA(-)}$	$V_{thc}$	 RA10-25

(c)

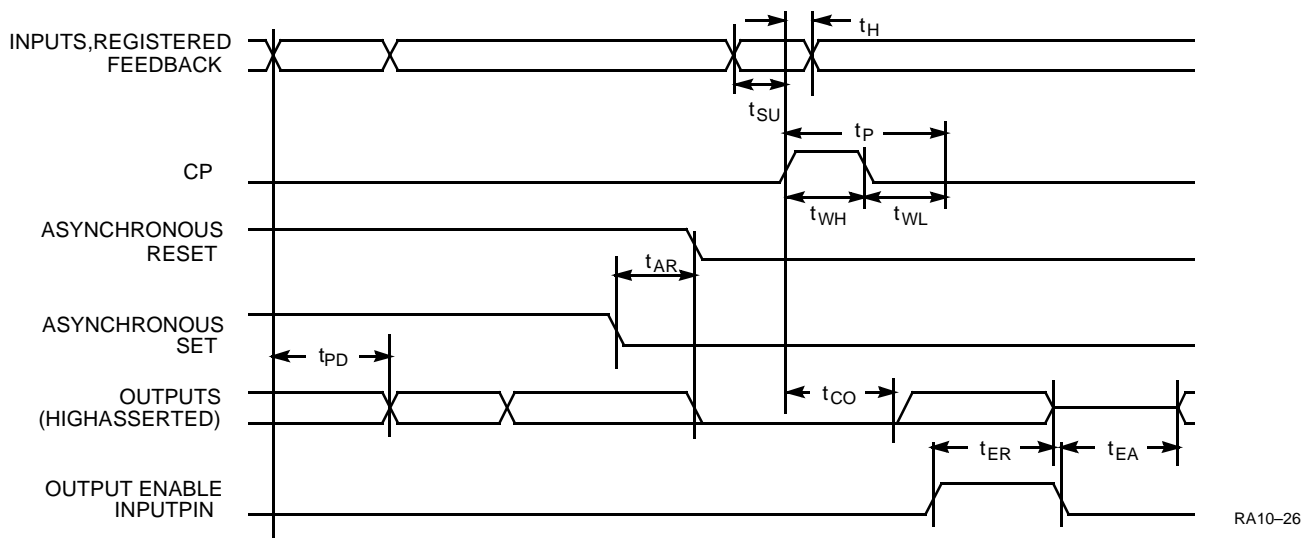
**Switching Characteristics** Over the Operating Range<sup>[3, 7, 8]</sup>

Parameter	Description	Commercial				Military						Unit
		−15		−20		−20		−25		−35		
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	Input or Feedback to Non-Registered Output		15		20		20		25		35	ns
t <sub>EA</sub>	Input to Output Enable		15		20		20		30		35	ns
t <sub>ER</sub>	Input to Output Disable		15		20		20		30		35	ns
t <sub>PZX</sub>	Pin 13 to Output Enable		12		15		15		20		25	ns
t <sub>PXZ</sub>	Pin 13 to Output Disable		12		15		15		20		25	ns
t <sub>CO</sub>	Clock to Output		15		20		20		25		35	ns
t <sub>SU</sub>	Input or Feedback Set-Up Time	7		10		10		15		20		ns
t <sub>H</sub>	Hold Time	3		5		3		5		5		ns
t <sub>P</sub>	Clock Period (t <sub>SU</sub> + t <sub>CO</sub> )	22		30		30		40		55		ns
t <sub>WH</sub>	Clock Width HIGH <sup>[5]</sup>	10		13		12		18		25		ns
t <sub>WL</sub>	Clock Width LOW <sup>[5]</sup>	10		13		12		18		25		ns
f <sub>MAX</sub>	Maximum Frequency (1/t <sub>P</sub> ) <sup>[5]</sup>	45.5		33.3		33.3		25.0		18.1		MHz
t <sub>S</sub>	Input of Asynchronous Set to Registered Output		15		20		20		25		40	ns
t <sub>R</sub>	Input of Asynchronous Reset to Registered Output		15		20		20		25		40	ns
t <sub>ARW</sub>	Asynchronous Reset Width <sup>[5]</sup>	15		20		20		25		25		ns
t <sub>ASW</sub>	Asynchronous S-Width <sup>[5]</sup>	15		20		20		25		25		ns
t <sub>AR</sub>	Asynchronous Set/Reset Recovery Time	10		12		12		15		20		ns
t <sub>WP</sub>	Preload Pulse Width	15		15		15		15		15		ns
t <sub>SUP</sub>	Preload Set-Up Time	15		15		15		15		15		ns
t <sub>HP</sub>	Preload Hold Time	15		15		15		15		15		ns

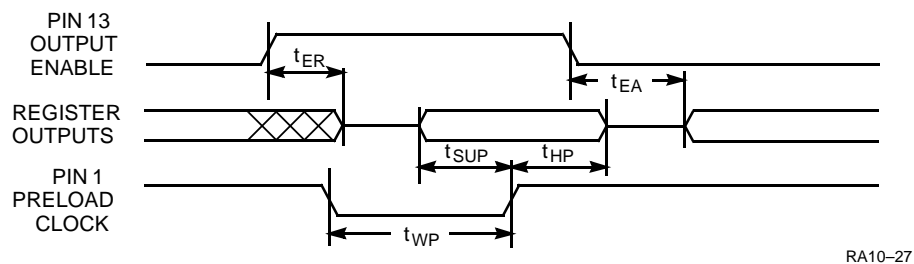
**Notes:**

7. Part (a) of AC Test Loads was used for all parameters except  $t_{EA}$ ,  $t_{ER}$ ,  $t_{PZX}$  and  $t_{PXZ}$ , which use part (b).
8. The parameters  $t_{ER}$  and  $t_{PXZ}$  are measured as the delay from the input disable logic threshold transition to  $V_{OH} - 0.5$  V for an enabled HIGH output or  $V_{OL} + 0.5$  V for an enabled LOW output. Please see part (c) of AC Test Loads and Waveforms for waveforms and measurement reference levels.

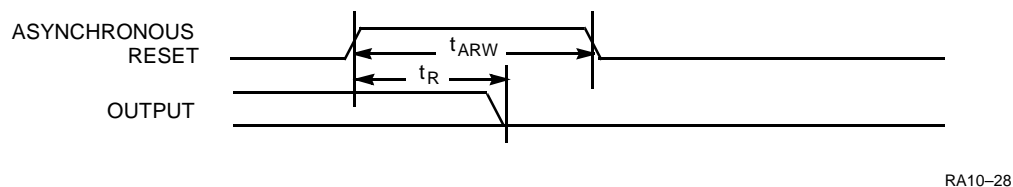
## Switching Waveform



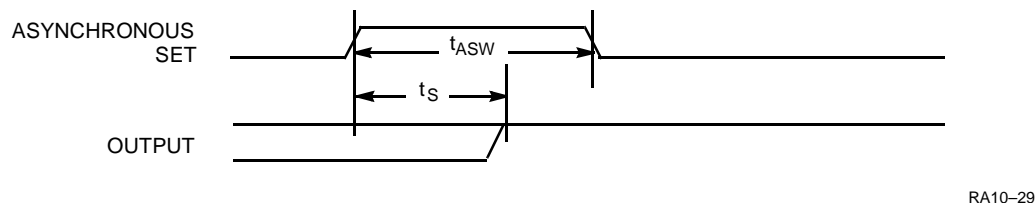
## Preload Switching Waveform



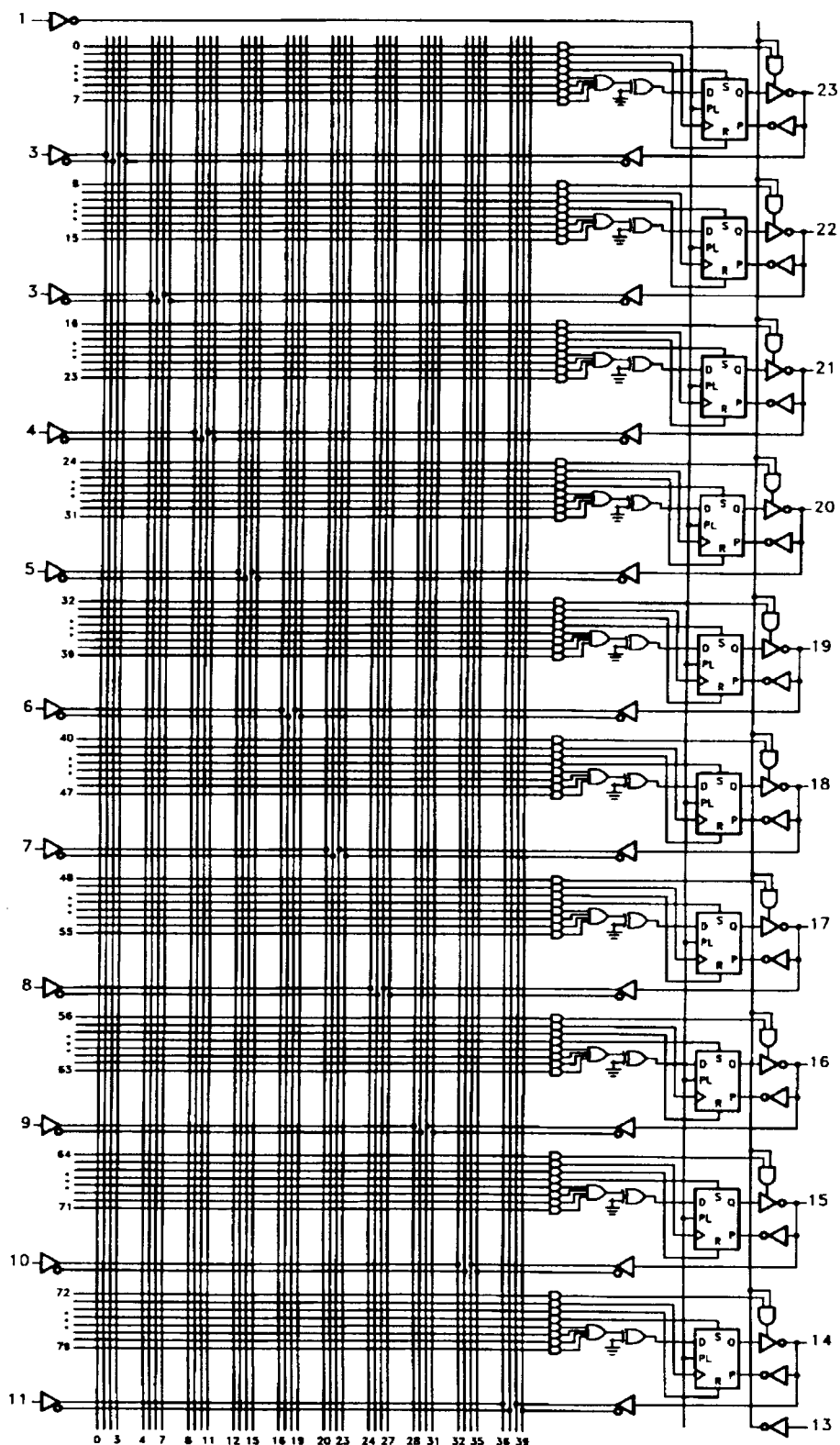
## Asynchronous Reset



## Asynchronous Set



# Functional Logic Diagram





**Ordering Information**

$I_{CC2}$	$t_{PD}$ (ns)	$t_{SU}$ (ns)	$t_{CO}$ (ns)	Ordering Code	Package Name	Package Type	Operating Range
80	15	7	15	PLDC20RA10-15JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
				PLDC20RA10-15PC	P13	24-Lead (300-Mil) Molded DIP	
				CG7C324-A15JC	J64	28-Lead Plastic Leaded Chip Carrier	
	20	10	20	PLDC20RA10-20PC	P13	24-Lead (300-Mil) Molded DIP	
				CG7C324-A20JC	J64	28-Lead Plastic Leaded Chip Carrier	
85	20	10	20	PLDC20RA10-20DMB	D14	24-Lead (300-Mil) CerDIP	Military
				PLDC20RA10-20WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
	25	15	25	PLDC20RA10-25DMB	D14	24-Lead (300-Mil) CerDIP	
				PLDC20RA10-25WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
	35	20	35	PLDC20RA10-35DMB	D14	24-Lead (300-Mil) CerDIP	
				PLDC20RA10-35WMB	W14	24-Lead (300-Mil) Windowed CerDIP	

**MILITARY SPECIFICATIONS**  
**Group A Subgroup Testing**
**DC Characteristics**

Parameter	Subgroups
$V_{OH}$	1, 2, 3
$V_{OL}$	1, 2, 3
$V_{IH}$	1, 2, 3
$V_{IL}$	1, 2, 3
$I_{IX}$	1, 2, 3
$I_{OZ}$	1, 2, 3

**DC Characteristics**

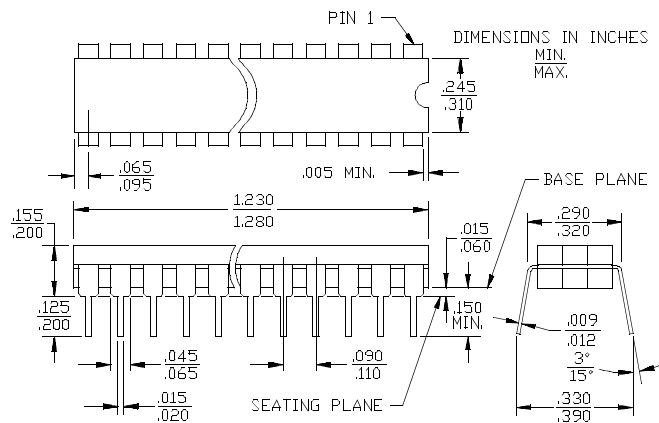
Parameter	Subgroups
$I_{CC}$	1, 2, 3

**Switching Characteristics**

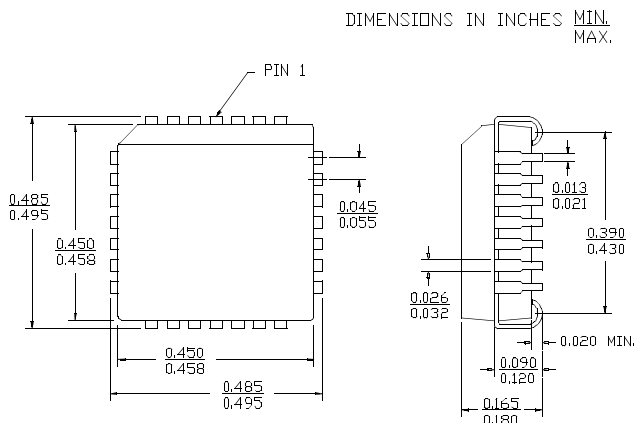
Parameter	Subgroups
$t_{PD}$	9, 10, 11
$t_{PZX}$	9, 10, 11
$t_{CO}$	9, 10, 11
$t_{SU}$	9, 10, 11
$t_H$	9, 10, 11

## Package Diagrams

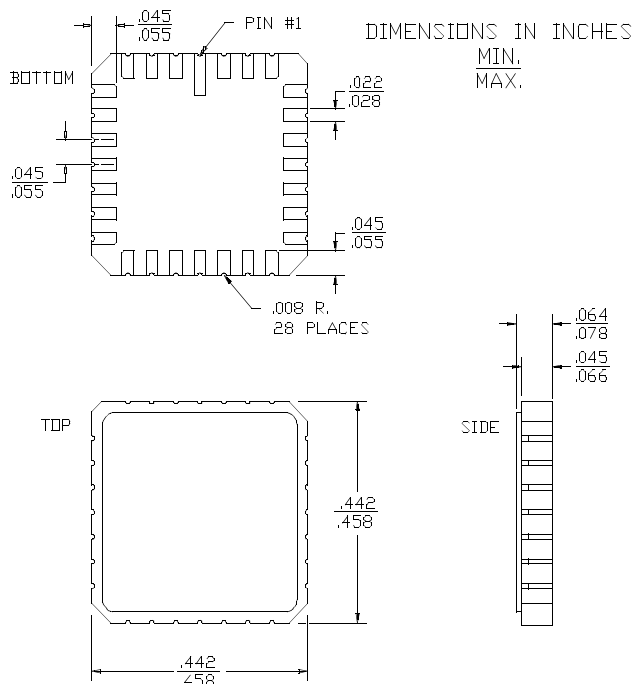
**24-Lead (300-Mil) CerDIP D14**  
MIL-STD-1835 D-9Config.A



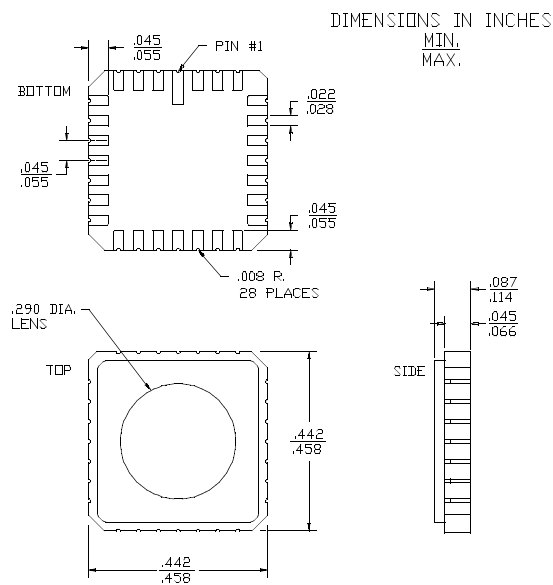
**28-Lead Plastic Leaded Chip Carrier J64**



**28-Square L64 Carrier Chip Leadless**  
MIL-STD-1835 C-4

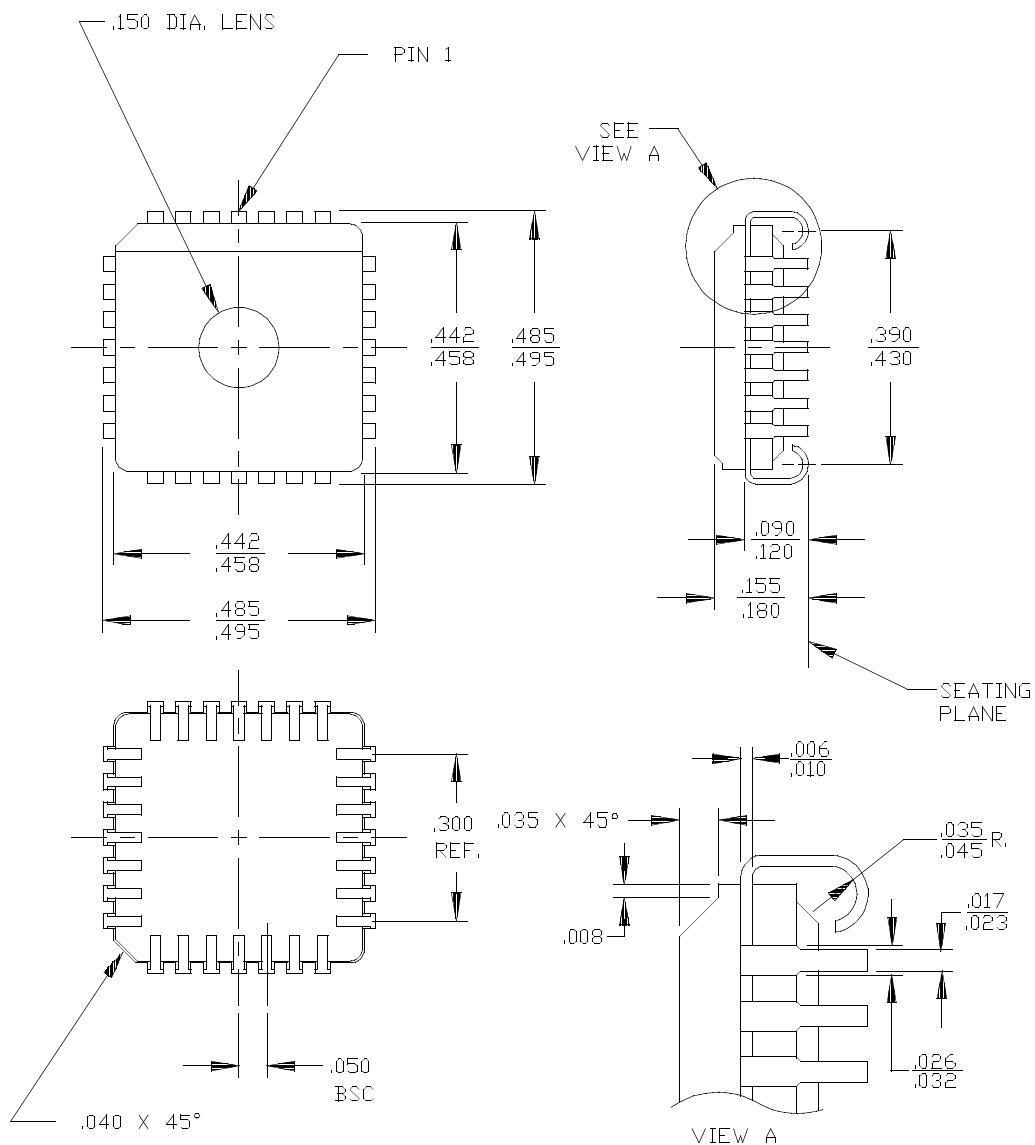


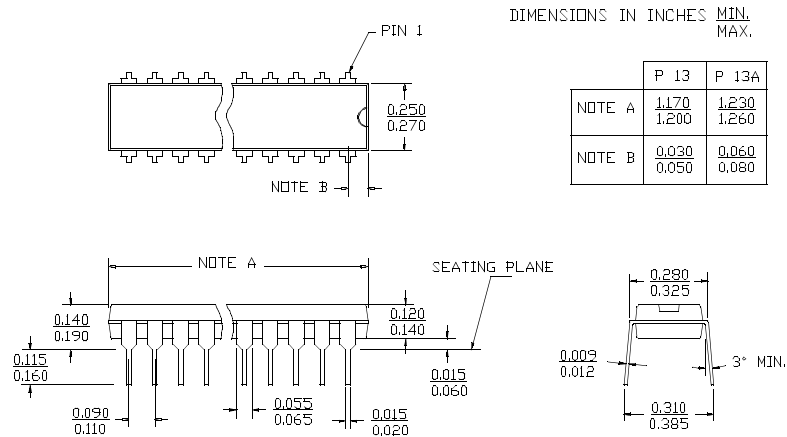
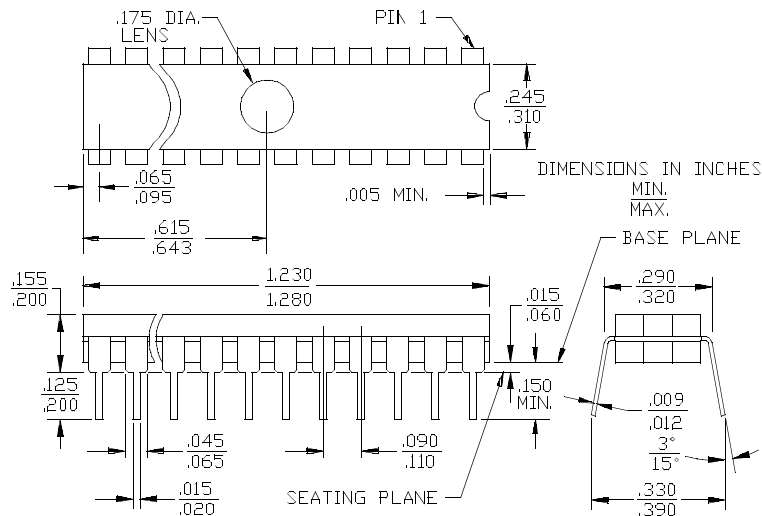
**28-Pin Windowed Leadless Chip Carrier Q64**  
MIL-STD-1835 C-4



Package Diagrams (continued)

28-Pin Windowed Leaded Chip Carrier H64



**Package Diagrams (continued)**
**24-Lead (300-Mil) Molded DIP P13/P13A**

**24-Lead (300-Mil) Windowed CerDIP W14**  
 MIL-STD-1835 D-9 Config.A


Document Title: PLDC20RA10 Reprogrammable Asynchronous CMOS Logic Device  
Document Number: 38-03012

REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	106294	04/24/01	SZV	Change from Spec number: 38-00073 to 38-03012